

ABSTRACT

A temporary-adhesive tape for dicing, including a substrate film and a temporary-adhesive layer on the substrate film, wherein the substrate film has a melting point of 150°C or lower; wherein a surface A of the substrate film on a side opposite to the temporary-adhesive layer has a surface roughness Ra of 0.10 μm or less; and wherein the surface A has a penetration temperature of 80°C or higher.